

GENERAL DESCRIPTION

C7171D is a CMOS LSI calculator chip with 8 digits arithmetic operations, single memory, percentage and extraction-of-square-root calculations, designed for triplex LCD application with solar cell power supply.

FUNCTIONS

- Four standard functions (+, -, x, +).
- Auto-constant calculations (constant : multiplicand, divisor, addend and subtrahend).
- Square and reciprocal calculations.
- Mark-up and mark-down calculations.
- Extraction of square root.
- Percentage calculations.
- Chain multiplication and division.
- Power calculations.
- Rough estimate calculations.

APPLICATION

This specification contains complete informations of functional operations, electrical characteristics, packaging, and crating requirements of C7171D.

FEATURES

- Accumulating memory : M+, M-, RM, CM, RM/CM.
- Rollover capability.
- Floating decimal.
- Overflow indication.
- 8-digit LCD triplex.
- Automatic power off function.

FUNCTIONAL DESCRIPTION

a. Floating point system

- i) 8 digits floating decimal point system, with leading zero suppression, Zero shift.
- ii) Symbols : '-' negative number indicator.
 : 'E' Error status indicator.
 : 'M' Non-zero memory indicator.

b. Error Detections

i) System errors occur when :

- The integral part of any calculation result exceeds 8 digits.
- The integral part of any memory calculation result exceeds 8 digits.
- The integral part of any addend or subtrahend to memory exceed 8 digits.
- The integral part of a mark-up or mark-down calculation result exceeds 8 digits.
- The division by zero.
- The extraction of square root of a negative number.

ii) Rough estimate calculation error

- The integral part of the result of any standard functions, percentage, square, reciprocal or power calculations exceeds 8 digits and is equal to 16 digits or less.

c. Error Indication

i) System error

'0' is indicated in the 1-digit position and 'E' in the sign indicator position.

ii) Rough estimate calculation error

The high-order 8 digits of a calculation result is indicated together with 'E'. The decimal point is indicated in the position corresponding to a calculation result times 10^{-8} , and no zero shift is performed.

d. Error Release

i) System error can be released by the ON/C or ON/CE key.

ii) Rough estimate calculation error can be released by the ON/C, ON/CE, CE key.

e. Number Entry

Numerical can be entered up to 8 digits, entries that equal to 9 digits or more will be ignored.

f. Memory Protection

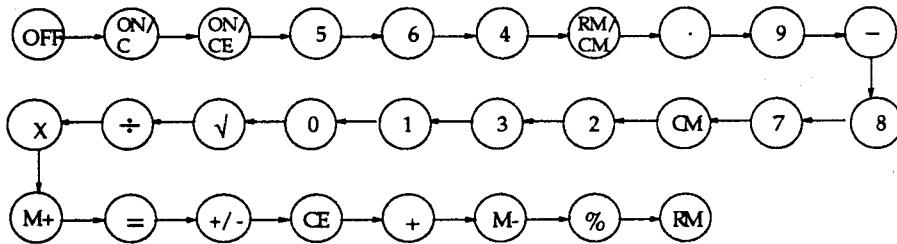
The memory contents before any error detection are protected.

g. Memory Indication

If the memory contents is non-zero, 'M' is indicated in the memory indicator position.

h. Double Key Depression

The order of priority when two keys are being depressed simultaneously is as follows :



When the OFF and ON/C key are depressed simultaneously, the OFF key is given priority.

i. Key bounce protection

i) Front edge : down to 1 word and up to about 3 words.

ii) Trailing edge : 9 words. (1 word is 3.3ms when display frequency is $F_d=100Hz$.)

j. Auto Power Off

Power automatically turns off after 9 - 11 minutes pass from the last key press.

k. Clear Operation

All operations except memory content are cleared by ON/C key.

ABSOLUTE MAXIMUM RATINGS

Parameters	Symbol	Value	Unit	Note
Terminal voltage	VDD	- 0.3 ~ + 2.0	V	1
	VIN	- 0.3 ~ VDD + 0.3	V	1
Solar Supply Voltage	VSB	1.1 ~ 3.0	V	2
	VGG (LIM)	1.1 ~ 1.8	V	3
Operating temperature range	TOPR	0 ~ + 50	°C	--
Storage temperature range	TSTG	- 55 ~ + 125	°C	--

Note 1 : Maximum voltage on any pin is referenced to GND.

Note 2 :VSB is solar supply voltage.

Note 3 :VGG (lim) is limited voltage.

ELECTRICAL CHARACTERISTICS

(Ta = 25°C, VDD = 1.5V unless otherwise specified)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Condition	Note
Input Voltage	V _{IH}	V _{DD} -0.4	--	--	V	--	4
	V _{IL}	--	--	0.4	V	--	
Input Current	I _{IH}	--	--	1	μA	V _{IN} = V _{DD}	5
	I _{IL}	0.3	1	3	μA	V _{IN} = 0V	
Output Voltage 1	V _{OH}	V _{DD} -0.15	--	--	V	No load	6
	V _{OL}	--	--	0.15	V	I _{OUT} = 15μA	
Output Voltage 2	V _{OA}	2.8	2.95	--	V	No load	7
	V _{OB}	1.3	1.5	1.7	V	No load	
	V _{OC}	--	0	0.2	V	No load	
Display Frequency	F _d	40	55	65	Hz	V _{DD} = 1.3V while display is ON.	7
Dissipation Current	I _{OFF}	--	--	0.1	μA	Display is OFF	8
	I _{DIS}	--	4.2	6	μA	V _{DD} = 1.3V while display is on.	9
	I _{OP}	--	6.8	--	μA	V _{DD} = 1.1V , while operation.	10

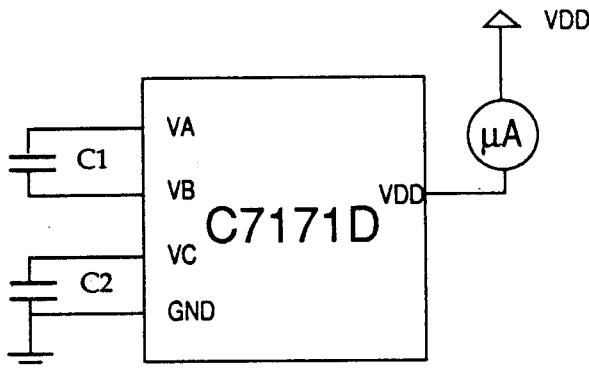
Note 4 : Applies to Pins K2 ~ K6.

Note 5 : Applies to Pins K2 ~ K6.

Note 6 : Applies to P1,P2, A2X ~ A5X.

Note 7 : Applies to H1 ~ H3, A1 ~ A8, B1 ~ B8, C1 ~ C8.

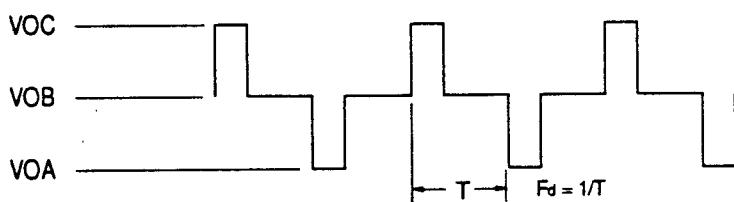
Note 8 : Measured by the test circuit below after power supply automatically turns off.



Note 9 : Measured by the test circuit while "0" is being displayed after auto - clear operation and while key is not being depressed.

Note 10 : Measured by the test circuit while operation is being made by ON/C key and while key is not being depressed.

LCD BACKPLANE OUTPUT WAVEFORM



DISPLAY FONTS

a. Numerical Font

0 1 2 3 4 5 6 7 8 9

b. Sign Font

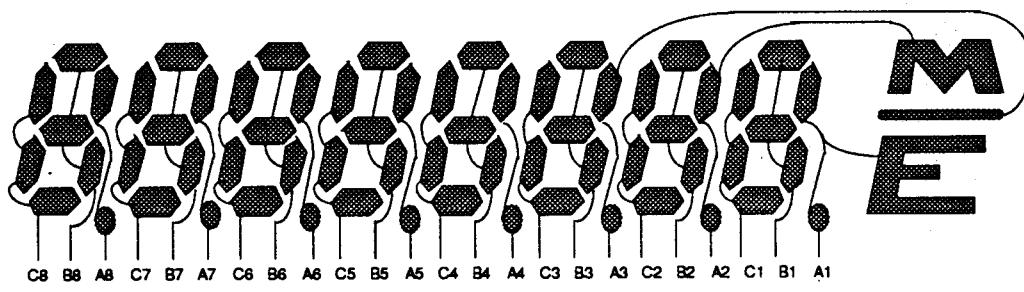
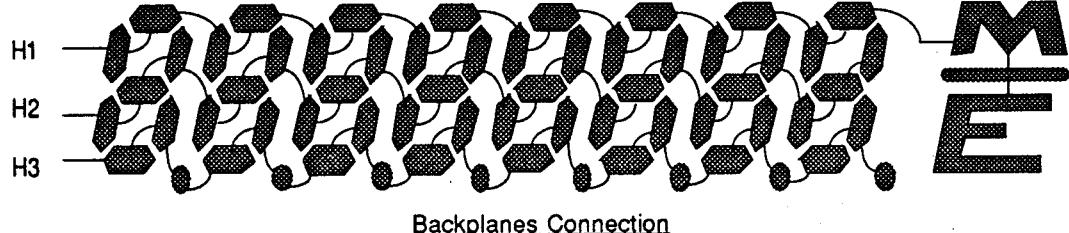
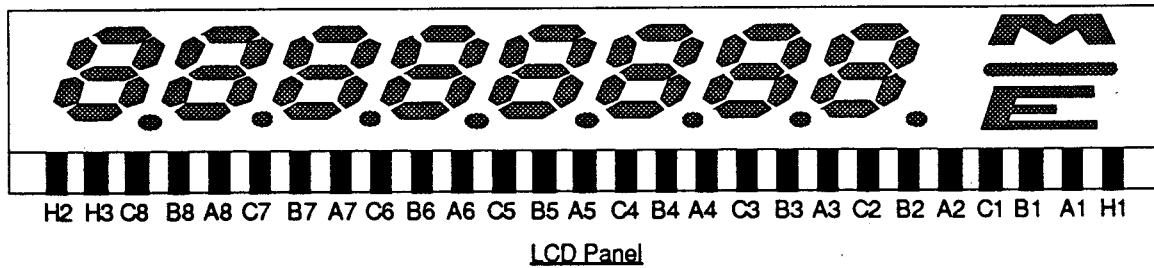
M - E

Memory indicator

Negative

Error indicator

LCD CONNECTOR



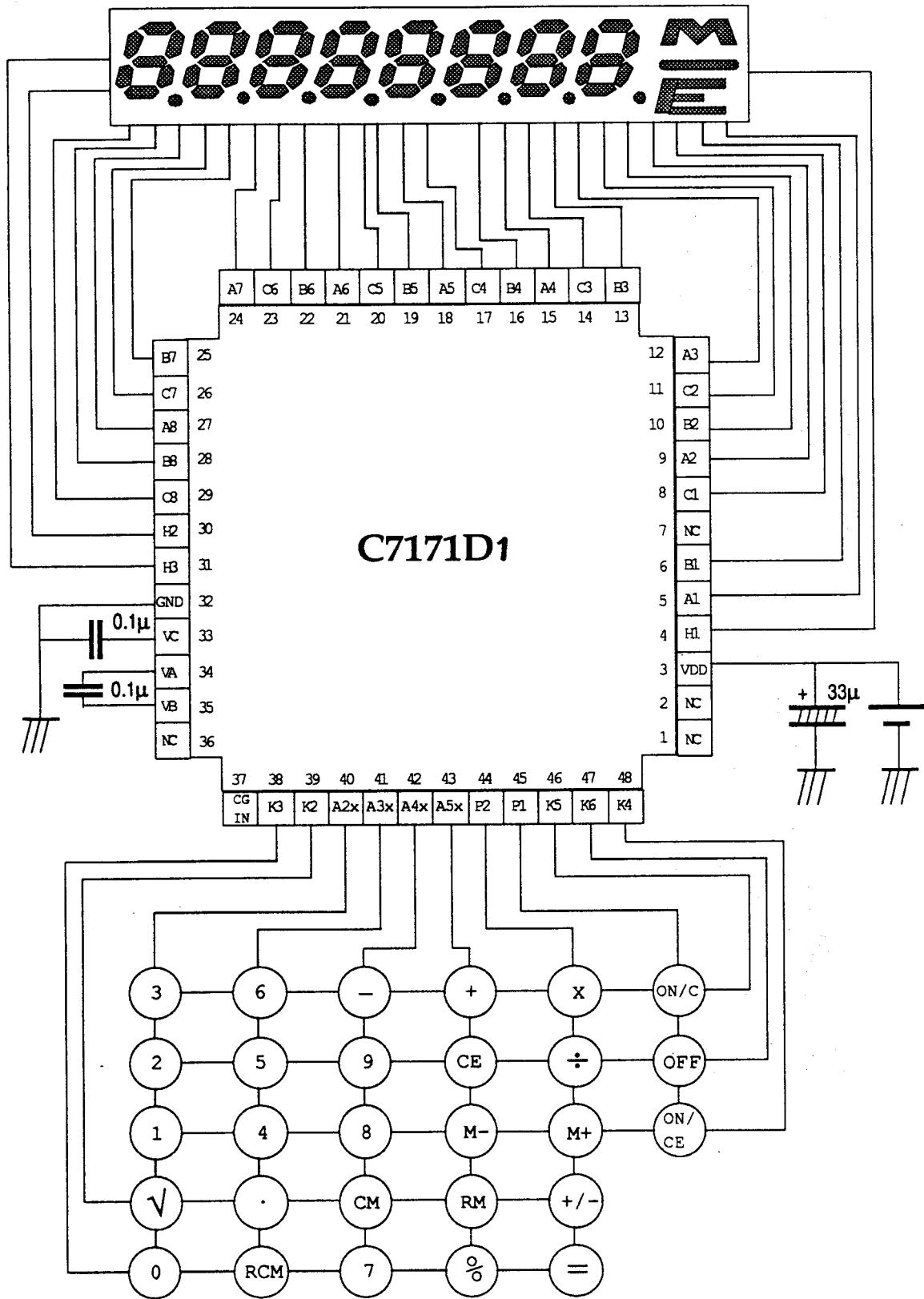
Segment Connection

PIN DESCRIPTION

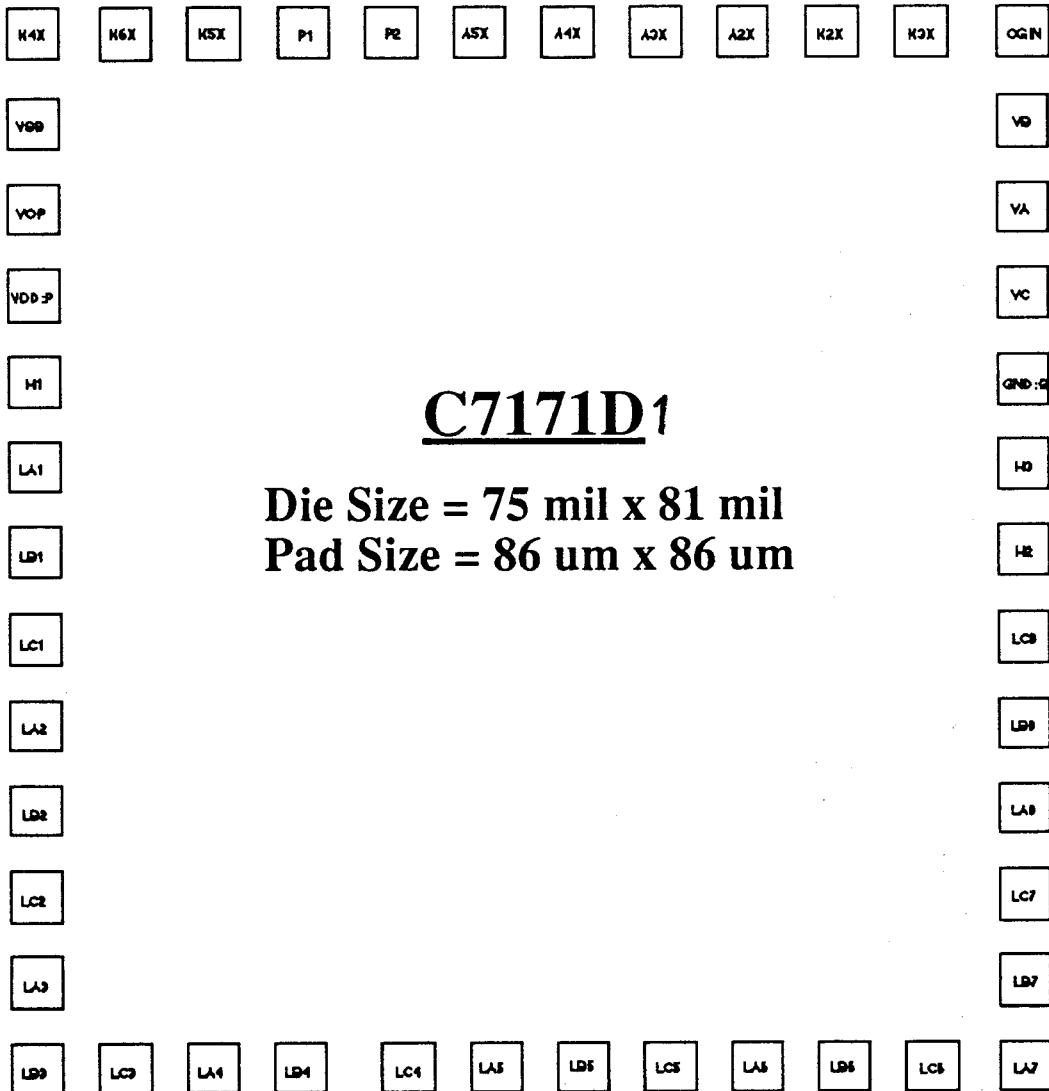
Pin No.	Signal	I/O	Description
1	NC	-	-
2	NC	-	-
3	VDD		Power supply.
4	H1	O	Display output.
5	A1	O	Display output.
6	B1	O	Display output.
7	NC	-	-
8	C1	O	Display output.
9	A2	O	Display output.
10	B2	O	Display output.
11	C2	O	Display output.
12	A3	O	Display output.
13	B3	O	Display output.
14	C3	O	Display output.
15	A4	O	Display output.
16	B4	O	Display output.
17	C4	O	Display output.
18	A5	O	Display output.
19	B5	O	Display output.
20	C5	O	Display output.
21	A6	O	Display output.
22	B6	O	Display output.
23	C6	O	Display output.
24	A7	O	Display output.

Pin No.	Signal	I/O	Description
25	B7	O	Display output.
26	C7	O	Display output.
27	A8	O	Display output.
28	B8	O	Display output.
29	C8	O	Display output.
30	H2	O	Display output.
31	H3	O	Display output.
32	GND		Ground.
33	VC	O	Cap terminal for voltage step-up.
34	VA	O	Cap terminal for voltage step-up.
35	VB	O	Cap terminal for voltage step-up.
36	NC	-	-
37	CGin	I	Input terminal for CG.
38	K3	I	Key input.
39	K2	I	Key input.
40	A2X	O	Strobe output.
41	A3X	O	Strobe output.
42	A4X	O	Strobe output.
43	A5X	O	Strobe output.
44	P2	O	Strobe output.
45	P1	O	Strobe output.
46	K5	I	Key input.
47	K6	I	Key input.
48	K4	I	Key input.

APPLICATION DIAGRAM

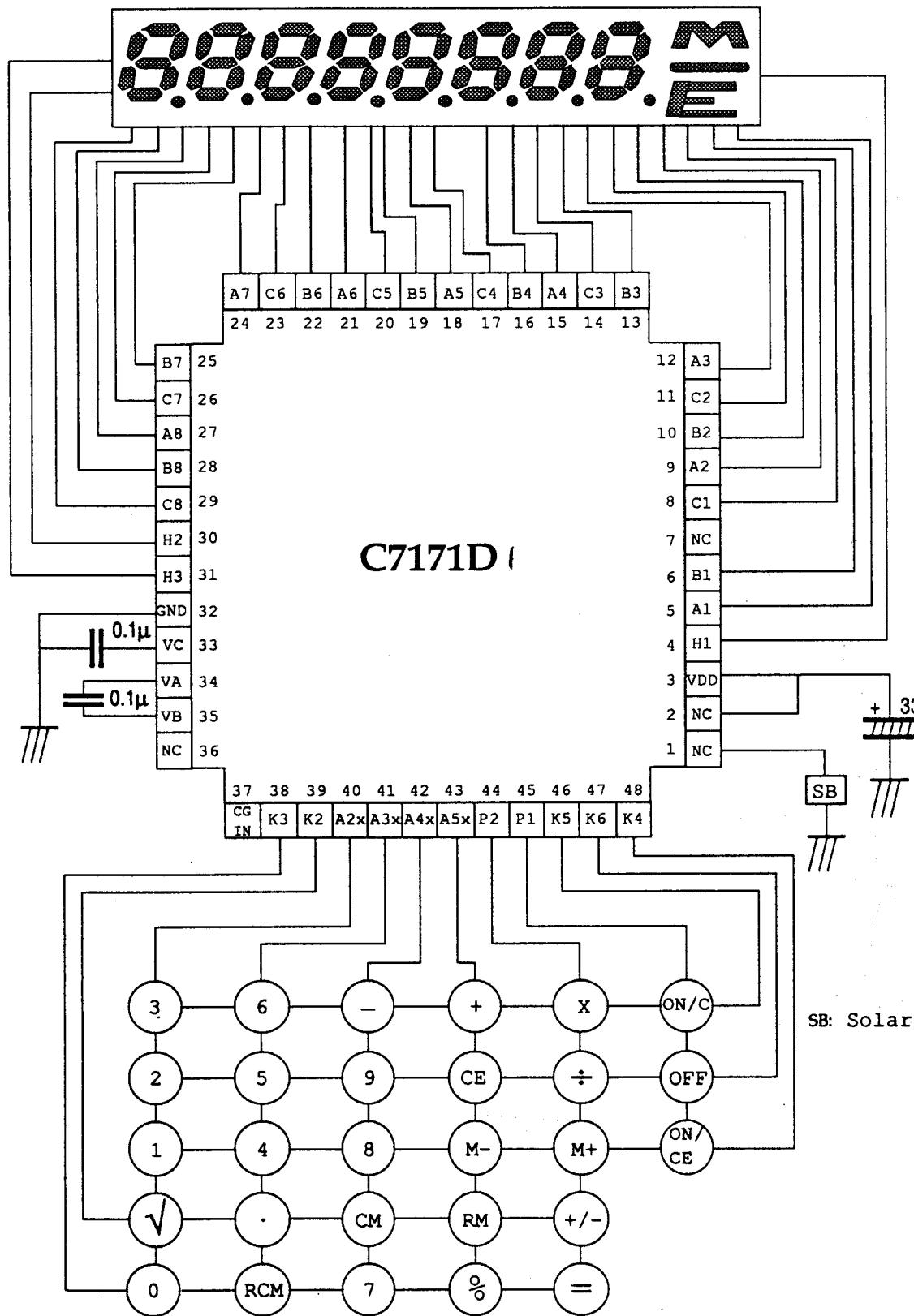


PAD DIAGRAM

The Co-ordinates of Low Left Corner for Each Pad

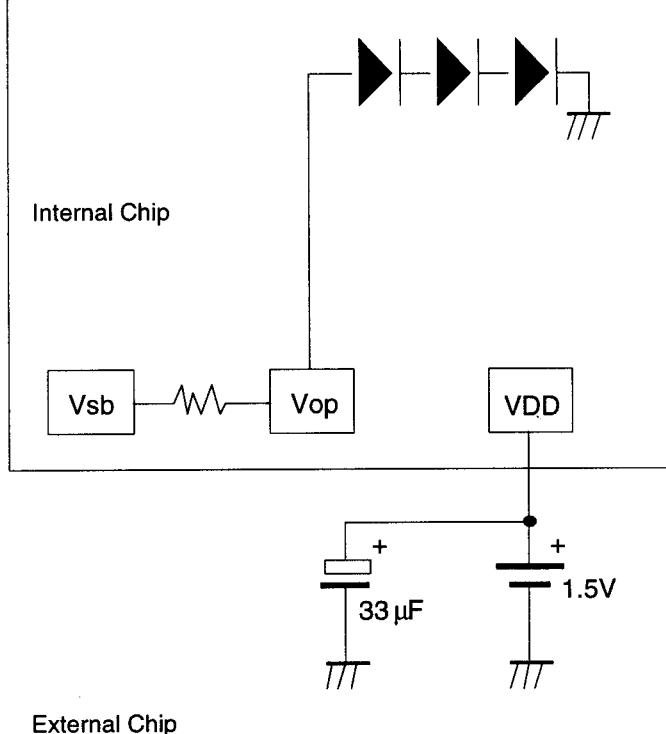
LB3(-869.0, -922.8)	LB7 (782.9, -776.7)	K3X(614.2, 836.7)	NC (-869.0, 683.2) VSS
LC3(-722.0, -922.8)	LC7 (782.9, -630.7)	K2X(467.2, 836.7)	NC (-869.0, 537.2) VOP
LA4(-575.6, -922.7)	LA8 (782.9, -484.7)	A2X(317.1, 836.7)	VDD (-869.0, 391.2)
LB4(-429.4, -922.7)	LB8 (782.9, -338.7)	A3X(170.1, 836.7)	H1 (-869.0, 245.2)
LC4(-249.5, -922.7)	LC8 (782.9, -192.1)	A4X(23.1, 836.7)	LA1 (-869.0, 99.2)
LA5(-103.5, -922.7)	H2 (782.9, -46.0)	A5X(-123.9, 836.7)	LB1 (-869.0, -46.8)
LB5(42.5, -922.7)	H3 (782.9, 100.1)	P2 (-270.9, 836.7)	LC1 (-869.0, -192.8)
LC5(188.5, -922.7)	GND (782.9, 246.1)	P1 (-417.9, 836.7)	LA2 (-869.0, -338.8)
LA6(334.8, -922.7)	VC (782.9, 392.1)	K5X(-567.2, 836.7)	LB2 (-869.0, -484.8)
LB6(480.9, -922.7)	VA (782.9, 538.1)	K6X(-714.7, 836.7)	LC2 (-869.0, -630.8)
LC6(627.0, -922.7)	VB (782.9, 684.1)	K4X(-869.0, 836.7)	LA3 (-869.0, -776.8)
LA7(782.9, -922.7)	CGIN (783.9, 836.7)		

APPLICATION DIAGRAM WITH SOLAR CELL



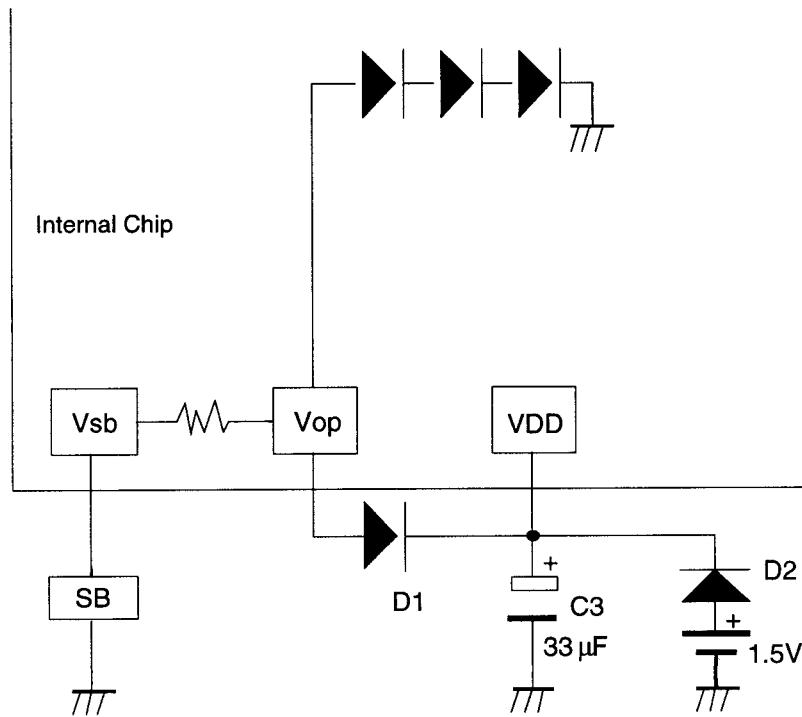
Note : Chip substract must be floating or connected to GND.

APPLICATION DIAGRAM FOR EXTERNAL BATTERY POWER SUPPLY



External Chip

APPLICATION DIAGRAM FOR DUAL POWER SUPPLY



External Chip

NOTE: D1 --- Cutting Voltage (0.2~0.3V). It should be a Germanium diode (Model No. IN60).
D2 --- Cutting Voltage (0.2~0.3V). It should be a Germanium diode (Model No. IN60).
SB --- Solar Battery